

MiniSKiiP[®] 3

3-phase bridge inverter

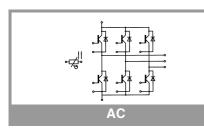
SKiiP 38AC176V2

Features

- Trench IGBTs
- Robust and soft freewheeling diodes in CAL technology
- Highly reliable spring contacts for electrical connections
- UL recognised: File no. E63532

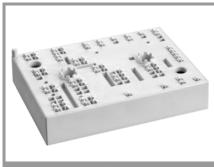
Remarks

- Max. case temperature limited to $T_{C}{=}125^{\circ}C$
- Product reliability results valid for $T_j \leq 150^{\circ}C$ (recommended $T_{j,op}$ =-40...+150°C)
- Please refer to MiniSKiiP "Technical Explanations" and "Mounting Instructions" for further information



Absolute	Maximum Rating	S					
Symbol	Conditions			Values		Unit	
Inverter -	IGBT						
V _{CES}	T _j = 25 °C			1700		V	
lc	λ_{paste} =0.8 W/(mK) T _j = 175 °C	T _s = 25 °C		118		А	
		T _s = 70 °C		95		Α	
I _C	λ_{paste} =2.5 W/(mK) T _j = 175 °C	T _s = 25 °C		151		Α	
		T _s = 70 °C		122		Α	
I _{Cnom}		-		100		Α	
I _{CRM}	$I_{CRM} = 2 \times I_{Cnom}$			200		Α	
V _{GES}				-20 20		V	
t _{psc}	$V_{CC} = 1200 V$ $V_{GE} \le 20 V$ $V_{CES} \le 1700 V$	T _j = 150 °C		10		μs	
Tj				-40 175		°C	
Inverse -	Diode					•	
IF	λ_{paste} =0.8 W/(mK) T _j = 175 °C	T _s = 25 °C		115		А	
		T _s = 70 °C		89		Α	
l _F	λ_{paste} =2.5 W/(mK) T _j = 175 °C	T _s = 25 °C		142		Α	
		T _s = 70 °C		111			
I _{Fnom}				150		Α	
I _{FRM}	I _{FRM} = 2 x I _{Fnom}			300			
I _{FSM}	10 ms, sin 180°, T _j = 150 °C			860			
Tj				-40 175			
Module	·					•	
I _{t(RMS)}	T _{terminal} = 80 °C, 20 A per spring			120			
T _{stg}				-40 125			
V _{isol}	AC sinus 50 Hz, t = 1 min			2500			
Characte	ristics						
Symbol	Conditions		min.	typ.	max.	Unit	
Inverter -	IGBT						
V _{CE(sat)}	$I_C = 100 \text{ A}$ $V_{GE} = 15 \text{ V}$ chiplevel	T _j = 25 °C		2.00	2.40	V	
		T _j = 150 °C		2.45	2.90	V	
VCE0	· ·	T; = 25 °C		1.00	1.20	V	

Inverter	- IGB I					
V _{CE(sat)}	$I_{\rm C} = 100 \rm{A}$	T _j = 25 °C		2.00	2.40	V
	V _{GE} = 15 V chiplevel	T _j = 150 °C		2.45	2.90	V
V _{CE0}	chiplevel	T _j = 25 °C		1.00	1.20	V
		T _j = 150 °C		0.90	1.10	V
r _{CE}	V _{GE} = 15 V	T _j = 25 °C		10	12	mΩ
	chiplevel	T _j = 150 °C		16	18	mΩ
V _{GE(th)}	$V_{GE} = V_{CE}, I_C = 4 \text{ mA}$		5.2	5.8	6.4	V
I _{CES}	$V_{GE} = 0 V, V_{CE} = 1700 V, T_j = 25 \ ^{\circ}C$			0.1	0.3	mA
Cies	$V_{CE} = 25 V$ $V_{GE} = 0 V$	f = 1 MHz		8.82		nF
Coes		f = 1 MHz		0.37		nF
C _{res}		f = 1 MHz		0.29		nF
Q _G	- 8 V+ 15 V			934		nC
R _{Gint}	T _j = 25 °C			4.8		Ω
t _{d(on)}	$I_{\rm C} = 100 {\rm A}$	T _j = 150 °C		160		ns
t _r		T _j = 150 °C		35		ns
Eon		T _j = 150 °C		23.8		mJ
t _{d(off)}		T _j = 150 °C		580		ns
t _f	di/dt _{off} = 600 A/µs	T _j = 150 °C		150		ns
E _{off}	du/dt = 4500 V/μs V _{GE} = +15/-15 V L _s = 40 nH	T _j = 150 °C		32.2		mJ
R _{th(j-s)}	per IGBT, λ _{paste} =0.8 W/(mK)			0.38		K/W
R _{th(j-s)}	per IGBT, λ_{paste} =2.5 W/(mK)			0.25		K/W



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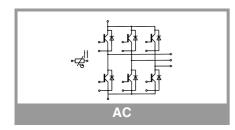
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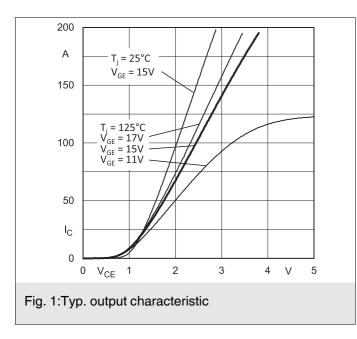
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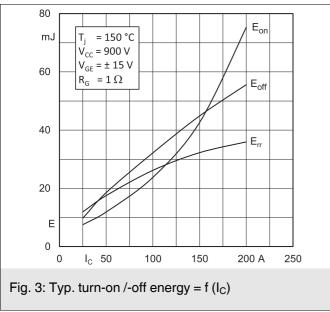
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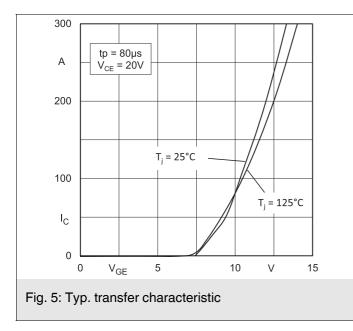
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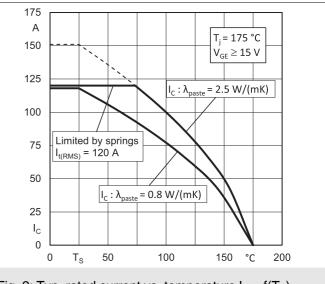
Characte	ristics					
Symbol	Conditions		min.	typ.	max.	Unit
Inverse -	Diode					
$V_F = V_{EC}$	I _F = 100 A	T _j = 25 °C		1.76	2.10	V
	V _{GE} = 0 V chiplevel	T _j = 150 °C		1.77	2.09	V
V _{F0}	chiplevel	T _j = 25 °C		1.32	1.56	V
		T _j = 150 °C		1.08	1.22	V
r _F	chiplevel	T _j = 25 °C		4.4	5.4	mΩ
		T _j = 150 °C		6.9	8.7	mΩ
I _{RRM}	di/dt _{off} = 4000 A/µs −+15/-15	T _j = 150 °C		226		Α
Q _{rr}		T _j = 150 °C		38.5		μC
E _{rr}		T _j = 150 °C		26.2		mJ
R _{th(j-s)}	per Diode, λ_{paste} =0.8 W/(mK)			0.61		K/W
R _{th(j-s)}	per Diode, λ_{paste} =2.5 W/(mK)			0.45		K/W
Module						
L _{CE}				20		nH
Ms	to heat sink		2		2.5	Nm
w				82		g
Temperat	ure Sensor					
R ₁₀₀	T _r =100°C (R ₂₅ =1000Ω)			1670 ± 3%		Ω
R(T)	R(T)=1000Ω[1+A(T-25°C)+B(T-25°C) ²], A = 7.635 [*] 10 ⁻³ °C ⁻¹ , B = 1.731 [*] 10 ⁻⁵ °C ⁻²					

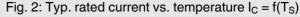


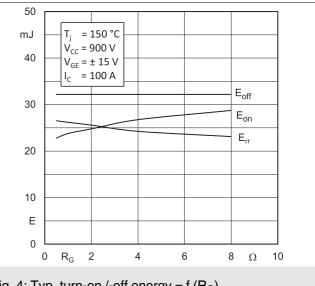


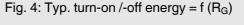


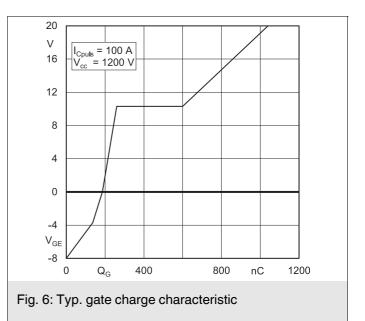


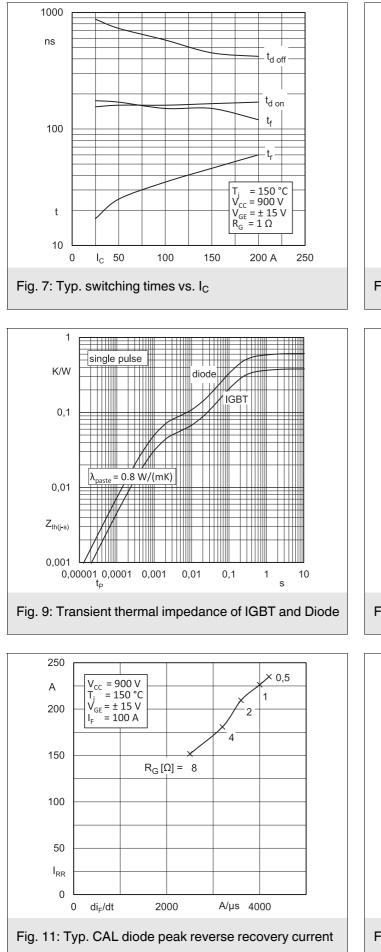


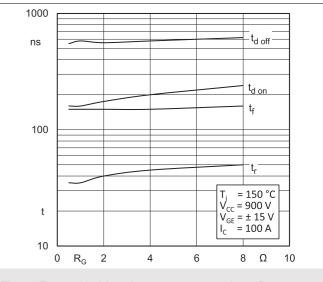














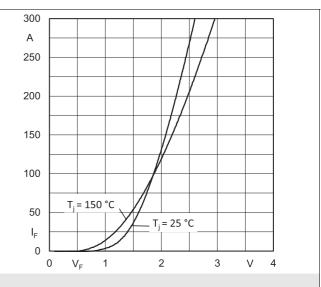
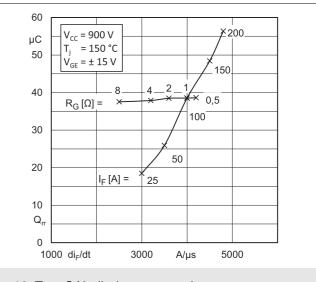
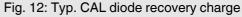
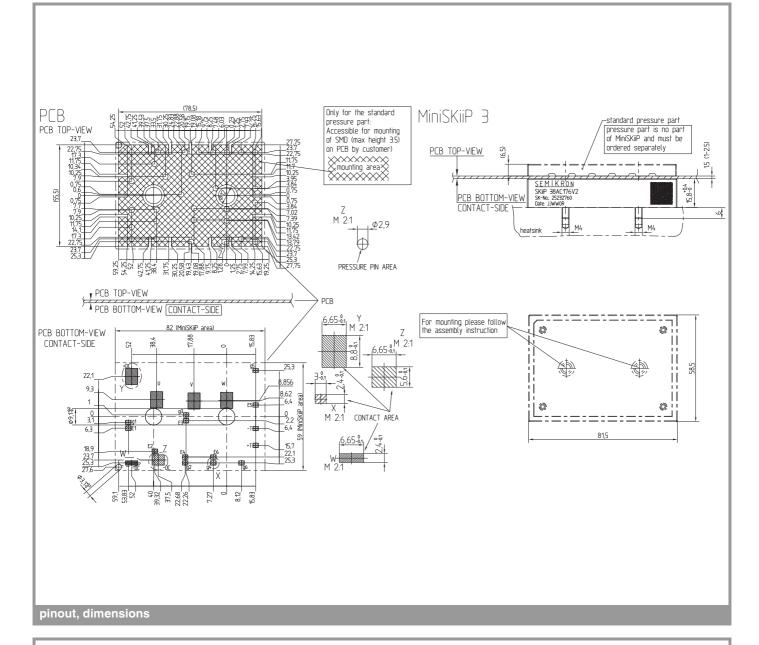
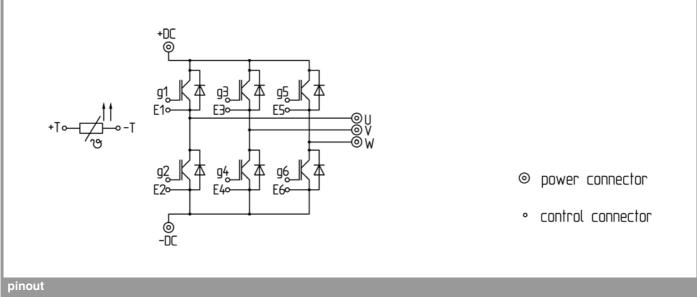


Fig. 10: CAL diode forward characteristic









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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, chapter IX.

***IMPORTANT INFORMATION AND WARNINGS**

The specifications of SEMIKRON products may not be considered as guarantee or assurance of product characteristics

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